

AGS-Electronics, Ph: +1-505-550-6501 or +1-505-565-5102, Fx: +1-505-814-5778, Em: sales@ags-electronics.com, Web: http://www.ags-electronics.com

	Capability & Tolerance for Flex-PC & Rigid-Flex Manufacturing						
Seq	Item		Process Capability				
1	Layer count		1-16 layer (contain of Rigid-Flex PCB)				
2	Base material		PI; PET (12.5um-125um)				
3	Copper foil		ED; RA				
4	Copper thickness		12um, 18um, 35um, 70um				
5	Scope of flex products		Single-sided FPC; Double-sided FPC; Multilayer FPC; Aluminum substrate; Copper substrate; Single-sided hollowed-out FPC (Sculptured Flex boards); Double-sided hollowed-out FPC (Sculptured Flex boards)				
6	Max finished size		340mm ×500mm (Whole roll: 13mm × 30m)				
7	Min finished size		6mm × 12mm				
8	Finished board thickness		0.075mm - 4.0mm				
9	Finished board thickness tolerance		±0.01mm				
40	Min line width / spacing	Single-sided	0.050mm (2mil)				
10		Double sided and Multilayer	0.075mm (3mil)				
11	Min drill size		0.2mm (8mil)				
12	Max drill size		6.5mm				
13	Min spacing from line to pad		0.1mm (4mil)				
14	Min spacing from line to edge	Steel die	±0.07mm				
14		Die cut	±0.2mm				



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15	Dimension tolerance	Line width	±0.03mm
		Hole size tolerance	±0.05mm
		Hole location tolerance	±0.05mm
		Outline tolerance	±0.1mm
		Etching tolerance	±0.25 mil
16	Tolerance from conductive to outline		±0.075mm
17	Tolerance for exposure and alignment		±0.05mm (2mil)
18	Tolerance for reinforcing (lay up stiffener) and alignment		< 0.10mm (4mil)
19	Tolerance of Inner against outerlayer		±0.05mm (2mil)
20	Solder mask		Liquid Photoimagible solder mask ink; Lamination coverlay
21	Surface treatment		OSP; ENIG; Ni/Au Plating; HASL (lead free); Pure-tin plating; Immersion Tin
22	Withstanding bending times		>150,000 cycles
23	Insulation resistance		1000 ΜΩ
24	Withstanding voltage		5 KV
25	Peeling strength		1.0Kg f/cm (PI); 1.2kg f/cm (PET)
26	Soldering strength		280°C/10 sec
27	Flammability		94V-0

Flex board thickness

Layer	Finished thickness (thinnest)	Finished thickness (thickest	Finished thickness (standard)
1 layer	2.4mil (0.06mm)	12mil (0.3mm)	6mil (0.15mm)
2 layer	4mil (0.1mm)	15.7mil (0.4mm)	8mil (0.2mm)
4 layer	10mil (0.25mm)	19.7mil (0.5mm)	12mil (0.3mm)
6 layer	15.7mil (0.4mm)	27.6mil (0.7mm)	17.7mil (0.45mm)
8 layer	19.7mil (0.5mm)	31.5mil (0.8mm)	21.7mil (0.55mm)